

MBRD620CT, MBRD630CT, MBRD640CT, MBRD650CT, MBRD660CT

MBRD620CT, MBRD640CT and MBRD660CT are Preferred Devices

SWITCHMODE™ Power Rectifiers

DPAK-3 Surface Mount Package

... in switching power supplies, inverters and as free wheeling diodes, these state-of-the-art devices have the following features:

- Extremely Fast Switching
- Extremely Low Forward Drop
- Platinum Barrier with Avalanche Guardrings

Mechanical Characteristics:

- Case: Epoxy, Molded
- Weight: 0.4 gram (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 75 units per plastic tube
- Available in 16 mm Tape and Reel, 2500 units per reel, by adding a "T4" suffix to the part number
- Marking: B620T, B630T, B640T, B650T, B660T

Features

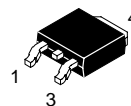
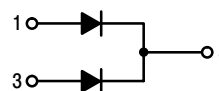
- Pb-Free Packages are Available



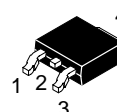
ON Semiconductor®

<http://onsemi.com>

SCHOTTKY BARRIER RECTIFIERS 6.0 A, 20 – 60 V



**DPAK-3
CASE 369A
PLASTIC**



**DPAK-3
CASE 369C
SINGLE GAUGE**

MARKING DIAGRAM



B6x0T = Device Code
x = 2, 3, 4, 5 or 6

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 2 of this data sheet.

Preferred devices are recommended choices for future use and best overall value.

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MAXIMUM RATINGS

Rating	Symbol	MBRD					Unit
		620CT	630CT	640CT	650CT	660CT	
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RRM} V_{RWM} V_R	20	30	40	50	60	V
Average Rectified Forward Current $T_C = 130^\circ\text{C}$ (Rated V_R)	Per Diode Per Device $I_{F(AV)}$	3 6					A
Peak Repetitive Forward Current, $T_C = 130^\circ\text{C}$ (Rated V_R , Square Wave, 20 kHz) Per Diode	I_{FRM}	6					A
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	I_{FSM}	75					A
Peak Repetitive Reverse Surge Current (2 μs , 1 kHz)	I_{RRM}	1					A
Operating Junction Temperature	T_J	-65 to +150					$^\circ\text{C}$
Storage Temperature	T_{stg}	-65 to +175					$^\circ\text{C}$
Voltage Rate of Change (Rated V_R)	dv/dt	10,000					V/ μs

THERMAL CHARACTERISTICS PER DIODE

Maximum Thermal Resistance, Junction to Case	$R_{\theta JC}$	6	$^\circ\text{C/W}$
Maximum Thermal Resistance, Junction to Ambient (Note 1.)	$R_{\theta JA}$	80	$^\circ\text{C/W}$

ELECTRICAL CHARACTERISTICS PER DIODE

Maximum Instantaneous Forward Voltage (Note 2.) $i_F = 3$ Amps, $T_C = 25^\circ\text{C}$ $i_F = 3$ Amps, $T_C = 125^\circ\text{C}$ $i_F = 6$ Amps, $T_C = 25^\circ\text{C}$ $i_F = 6$ Amps, $T_C = 125^\circ\text{C}$	V_F	0.7 0.65 0.9 0.85	V
Maximum Instantaneous Reverse Current (Note 2.) (Rated dc Voltage, $T_C = 25^\circ\text{C}$) (Rated dc Voltage, $T_C = 125^\circ\text{C}$)	i_R	0.1 15	mA

1. Rating applies when surface mounted on the minimum pad size recommended.
2. Pulse Test: Pulse Width = 300 μs , Duty Cycle $\leq 2.0\%$.

ORDERING INFORMATION

Device	Package	Shipping [†]
MBRD620CTT4	DPAK-3 (369C)	2500 Tape & Reel
MBRD620CTT4G	DPAK-3 (369C) (Pb-Free)	75 Tape & Reel
MBRD630CTT4	DPAK-3	2500 Tape & Reel
MBRD640CTT4		
MBRD640CTT4G	DPAK-3 (Pb-Free)	75 Tape & Reel
MBRD650CT	DPAK-3	75 Units / Rail
MBRD650CTT4		75 Tape & Reel
MBRD660CT		75 Units / Rail
MBRD650CTRL		1800 Tape & Reel
MBRD660CTT4		2500 Tape & Reel
MBRD640CT		75 Units / Rail
MBRD650CT1		

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

TYPICAL CHARACTERISTICS

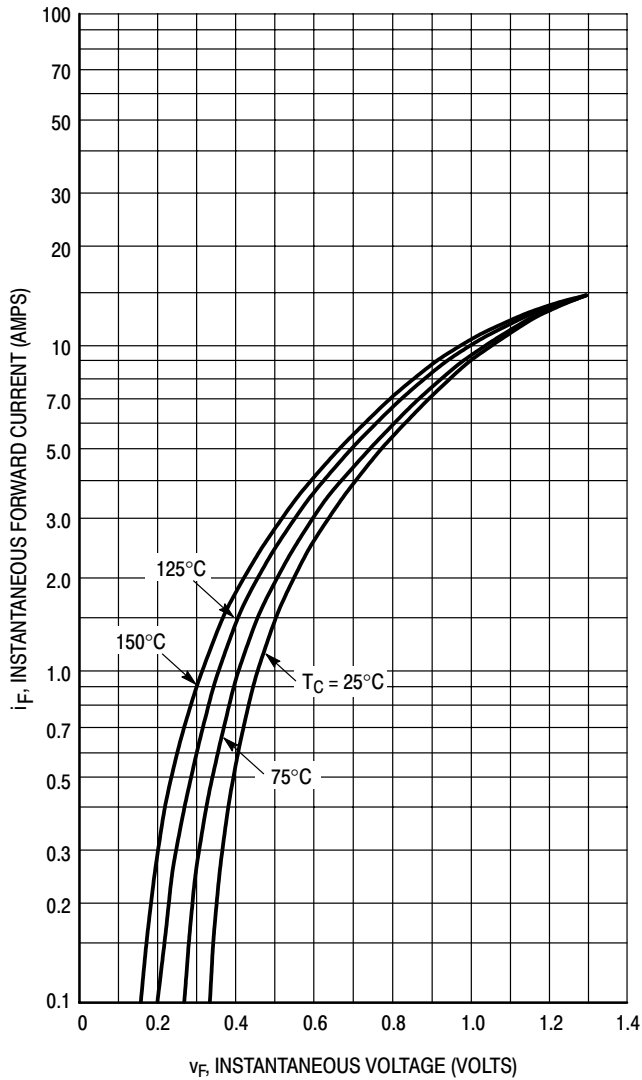
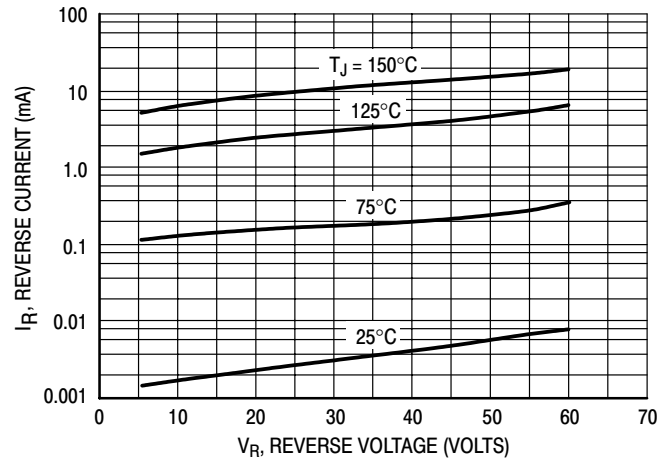


Figure 1. Typical Forward Voltage, Per Leg



*The curves shown are typical for the highest voltage device in the voltage grouping. Typical reverse current for lower voltage selections can be estimated from these curves if V_R is sufficient below rated V_R .

Figure 2. Typical Reverse Current, * Per Leg

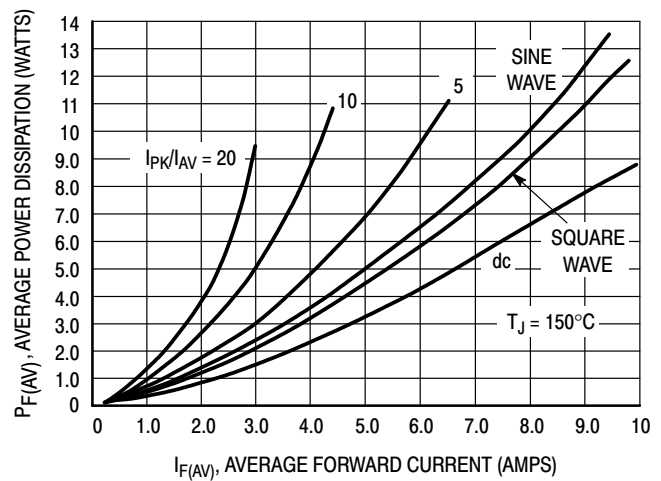


Figure 3. Average Power Dissipation, Per Leg

MBRD620CT, MBRD630CT, MBRD640CT, MBRD650CT, MBRD660CT

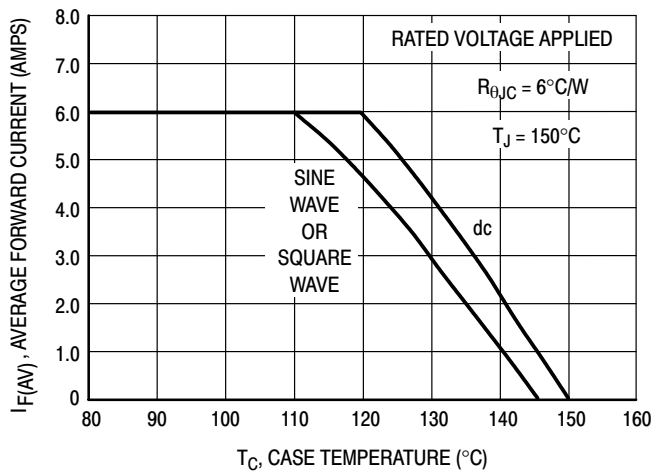


Figure 4. Current Derating, Case, Per Leg

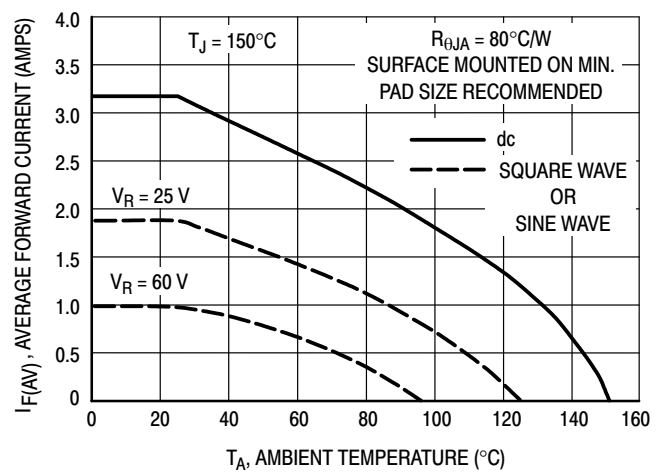


Figure 5. Current Derating, Ambient, Per Leg

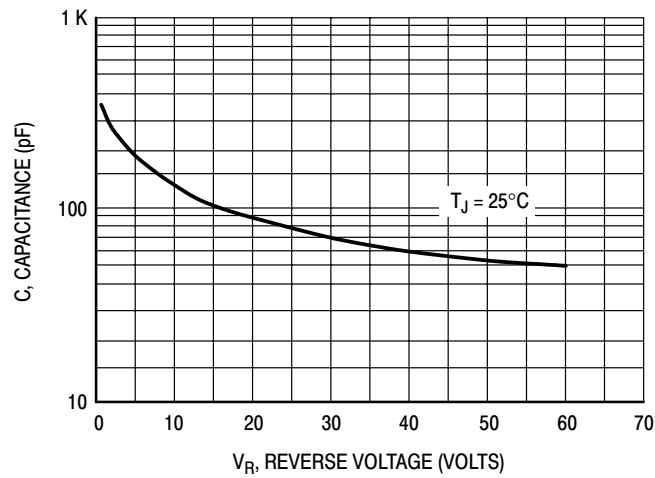
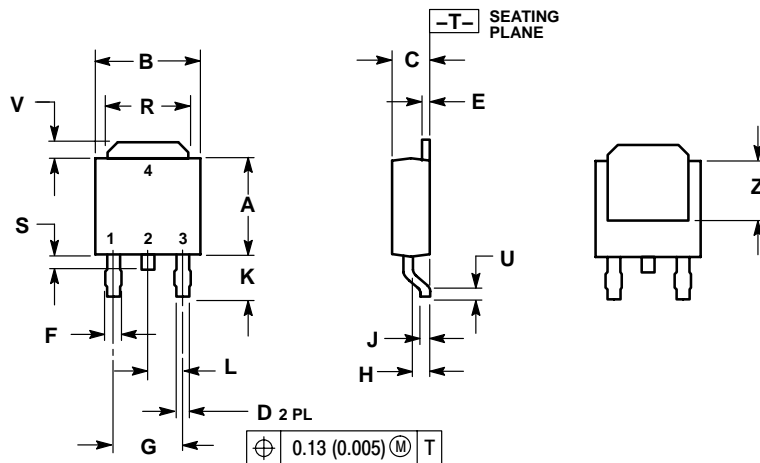


Figure 6. Typical Capacitance, Per Leg

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PACKAGE DIMENSIONS

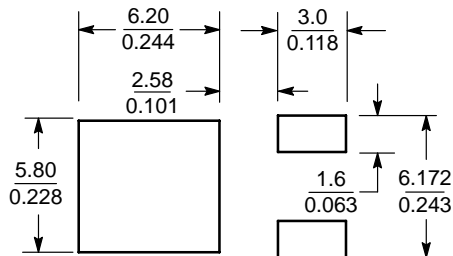
DPAK-3 SINGLE GAUGE CASE 369C ISSUE O



- NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 2. CONTROLLING DIMENSION: INCH.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.235	0.245	5.97	6.22
B	0.250	0.265	6.35	6.73
C	0.086	0.094	2.19	2.38
D	0.027	0.035	0.69	0.88
E	0.018	0.023	0.46	0.58
F	0.037	0.045	0.94	1.14
G	0.180 BSC		4.58 BSC	
H	0.034	0.040	0.87	1.01
J	0.018	0.023	0.46	0.58
K	0.102	0.114	2.60	2.89
L	0.090 BSC		2.29 BSC	
R	0.180	0.215	4.57	5.45
S	0.025	0.040	0.63	1.01
U	0.020	---	0.51	---
V	0.035	0.050	0.89	1.27
Z	0.155	---	3.93	---

SOLDERING FOOTPRINT*



SCALE 3:1 $\left(\frac{\text{mm}}{\text{inches}} \right)$

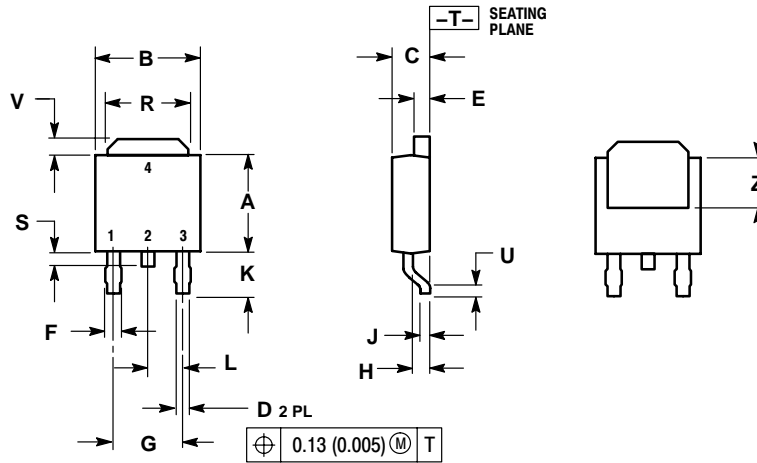
DPAK-3

*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

MBRD620CT, MBRD630CT, MBRD640CT, MBRD650CT, MBRD660CT

PACKAGE DIMENSIONS

DPAK-3 PLASTIC CASE 369A-13 ISSUE AB

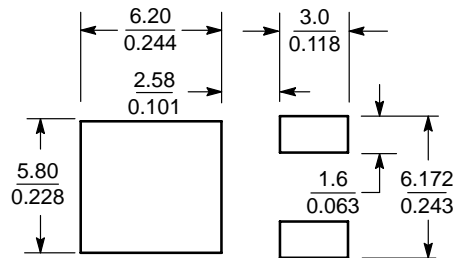


NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.235	0.250	5.97	6.35
B	0.250	0.265	6.35	6.73
C	0.086	0.094	2.19	2.38
D	0.027	0.035	0.69	0.88
E	0.033	0.040	0.84	1.01
F	0.037	0.047	0.94	1.19
G	0.180 BSC		4.58 BSC	
H	0.034	0.040	0.87	1.01
J	0.018	0.023	0.46	0.58
K	0.102	0.114	2.60	2.89
L	0.090 BSC		2.29 BSC	
R	0.175	0.215	4.45	5.46
S	0.020	0.050	0.51	1.27
U	0.020	---	0.51	---
V	0.030	0.050	0.77	1.27
Z	0.138	---	3.51	---

SOLDERING FOOTPRINT*




SCALE 3:1 (mm/inches)

DPAK-3

*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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